



2827  
JH

October 18, 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re/ Application of William James Palmteer et al.  
Application No. 09/966,222  
Filed September 28, 2001

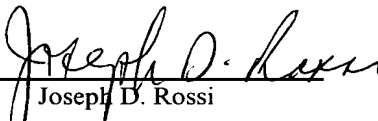
Examiner D. Zarneke  
Art Unit 2827  
Confirmation No. 5902

**Leadframe-Based Chip Scale Package**

(Atty. Docket No. 17658)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on Monday, October 18, 2004.

  
\_\_\_\_\_  
Joseph D. Rossi

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Reply Under 37 C.F.R. § 1.111 to  
Office Action Dated July 21, 2004

In response to the Official Action dated July 21, 2004 ("the Office Action"),  
reconsideration is respectfully requested in view of the amendments and/or remarks as indicated  
below.

U.S. Application No. 09/966,222  
Art Unit 2827

August 2, 2004  
Attorney Docket No. 17658  
Page 2

**Amendments to the Claims** are reflected in the "Listing of Claims," which begins on page 3 of this paper.

**Remarks** begin on page 7 of this paper.